

L Number	Hits	Search Text	DB	Time stamp
100	17	((("257/532").CCLS.) and package same capacitor and @pd>=20011025	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/11/13 13:53

L Number	Hits	Search Text	DB	Time stamp
1	56	organic adj binder with polyimide	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/13 08:53
8	6	organic adj binder with polyimide and (438/\$6 257/\$6)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/13 08:59
15	73	(polymer polymeric polyimide) with particle\$1 near3 (dielectric insulat\$4 non adj conductive) and (438/\$6 257/\$6)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/13 09:27
22	10	Cozar-Ricardo	EPO	2002/11/13 09:26
23	32	substrate with (polymer polymeric polyimide) with (blend\$3 fill\$3 load\$3) near3 (dielectric insulat\$4 non adj conductive) and (438/\$6 257/\$6)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/13 09:37
30	248	substrate with (polymer polymeric polyimide) with (solvent plasticizer dispersant) and (438/\$6 257/\$6)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/13 09:40
37	4	(substrate with (polymer polymeric polyimide) with (solvent plasticizer dispersant) and (438/\$6 257/\$6)) and substrate with (polymer polymeric polyimide) with (plasticizer dispersant) and (438/\$6 257/\$6)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/13 09:43
44	3	(substrate with (polymer polymeric polyimide) with (solvent plasticizer dispersant) and (438/\$6 257/\$6)) and substrate with (polymer polymeric polyimide) with (organic adj binder\$1) and (438/\$6 257/\$6)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/13 09:45
51	3	(substrate with (polymer polymeric polyimide) with (solvent plasticizer dispersant) and (438/\$6 257/\$6)) and (poly\$5) with (organic adj binder\$1) and (438/\$6 257/\$6)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/13 10:08
65	188	kapton adj e	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/13 10:11
58	28	dupont with KJ	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/13 10:10
72	51	kapton adj e and (438/\$6 257/\$6)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/13 11:17
79	2	("5455390").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/13 11:17
86	0	((("5455390").PN.) and solder with "30"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/13 11:17

93	1	((("5455390").PN.) and solder	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/13 11:17
-	1210	(257/532).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/24 15:16
-	14	((("4945399") or ("5027253") or ("3780352") or ("4982311") or ("5212402"))).PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/24 15:20
-	69	((("257/532").CCLS.) and package same capacitor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/02/04 15:13
-	15446	conduct\$5 adj trac\$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/24 15:55
-	25	conduct\$5 adj trac\$4 and (("257/532").CCLS.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/24 16:06
-	1382	conduct\$5 adj trace\$1 and capacitor\$1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/24 16:09
-	348	conduct\$5 adj trace\$1 and capacitor\$1 and (438/\$ 257/\$) not (conduct\$5 adj trac\$4 and (("257/532").CCLS.))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/24 16:21
-	97	induct\$5 with capac\$5 and conduct\$5 adj trace\$1 and capacitor\$1 and (438/\$ 257/\$) not (conduct\$5 adj trac\$4 and (("257/532").CCLS.))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/25 09:13
-	22	5639989.URPN.	USPAT	2001/10/24 16:42
-	9	("5146047"   "5166772"   "5166864"   "5175613"   "5341274"   "5379185"   "5392197"   "5394304"   "5513078").PN.	USPAT	2001/10/24 16:42
-	1	("4982311").PN.	USPAT	2001/10/25 09:13
-	19	4982311.URPN.	USPAT	2001/10/25 09:13
-	6	("4249196"   "4577214"   "4654694"   "4724472"   "4744008"   "4755910").PN.	USPAT	2001/10/25 09:13
-	81	((("257/532").CCLS.) and (dielectric insulat\$3) adj substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/25 10:21
-	626	((("257/532").CCLS.) and capacitance	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/25 10:22
-	251	((("257/532").CCLS.) and capacitance with ("2" "30" "5" "15" "30"))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/25 10:25

-	2	((("257/532").CCLS.) and capacitance with ("2" "30" "5" "15" "30") near nf\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/25 11:18
-	86	capacitance with ("2" "30" "5" "15" "30") near nf\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/25 10:34
-	0	capacitance with ("2" "30" "5" "15" "30") near "nf/sq.cm"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/25 10:35
-	5	capacitance with ("2" "30" "5" "15" "30") near "nf/cm.sup.2"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/25 11:05
-	5	((("257/532").CCLS.) and "nf/cm.sup.2"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/25 10:43
-	0	((("257/532").CCLS.) and (ground adj2 plane and power adj2 plane) with um	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/25 10:56
-	0	((("257/532").CCLS.) and (ground adj2 plane and power adj2 plane) with "um"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/25 10:59
-	14	((("257/532").CCLS.) and "um"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/25 10:59
-	0	"um" same "nf/cm.sup.2"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/25 11:18
-	4	((("257/532").CCLS.) and polyimide near3 substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/25 11:46
-	0	((("257/532").CCLS.) and solder adj plug	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/25 11:46
-	190	solder adj plug	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/25 11:46
-	1	solder adj plug with interconnect	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/25 11:47
-	3	solder adj plug with interconnect\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/25 12:01

-	18	(non adj conduct\$4 nonconduct\$4 insulat\$4 dielectric) near2 polymer same (BST PZT)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/25 12:11
-	10	(non adj conduct\$4 nonconduct\$4 insulat\$4 dielectric) near2 polymer with (BST PZT)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/25 12:04
-	8	((non adj conduct\$4 nonconduct\$4 insulat\$4 dielectric) near2 polymer same (BST PZT)) not ((non adj conduct\$4 nonconduct\$4 insulat\$4 dielectric) near2 polymer with (BST PZT))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/25 12:11
-	6	((("6184567") or ("5633785") or ("5883428") or ("6068782") or ("5639989") or ("4982311")).PN.	USPAT	2002/02/04 14:31
-	0	6184567.URPN.	USPAT	2002/02/04 14:29
-	5	("4494169"   "5099388"   "5144526"   "5590017"   "5767564").PN.	USPAT	2002/02/04 14:29
-	1	6068782.URPN.	USPAT	2002/02/04 14:30
-	18	("4065742"   "4409608"   "4437140"   "4460938"   "4490429"   "4650544"   "4878155"   "4908258"   "5010641"   "5027253"   "5065284"   "5079069"   "5155655"   "5161086"   "5162977"   "5261153"   "5347258"   "5656834").PN.	USPAT USPAT	2002/02/04 14:30 2002/02/04 14:30
-	2	5883428.URPN.	USPAT	2002/02/04 14:30
-	7	("4835344"   "5370907"   "5371403"   "5394008"   "5399902"   "5402318"   "5468694").PN.	USPAT	2002/02/04 14:30
-	22	5639989.URPN.	USPAT	2002/02/04 14:30
-	9	("5146047"   "5166772"   "5166864"   "5175613"   "5341274"   "5379185"   "5392197"   "5394304"   "5513078").PN.	USPAT USPAT	2002/02/04 14:30 2002/02/04 14:30
-	12	5633785.URPN.	USPAT	2002/02/04 14:30
-	13	("3566203"   "4744008"   "4945399"   "4949163"   "4984065"   "4994895"   "5049979"   "5055966"   "5119172"   "5148265"   "5148266"   "5281846"   "5311057").PN.	USPAT USPAT	2002/02/04 14:30 2002/02/04 14:30
-	20	4982311.URPN.	USPAT	2002/02/04 14:30
-	6	("4249196"   "4577214"   "4654694"   "4724472"   "4744008"   "4755910").PN.	USPAT	2002/02/04 14:30
-	113	(6184567.URPN. (("4494169"   "5099388"   "5144526"   "5590017"   "5767564").PN.) 6068782.URPN. (("4065742"   "4409608"   "4437140"   "4460938"   "4490429"   "4650544"   "4878155"   "4908258"   "5010641"   "5027253"   "5065284"   "5079069"   "5155655"   "5161086"   "5162977"   "5261153"   "5347258"   "5656834").PN.) 5883428.URPN. (("4835344"   "5370907"   "5371403"   "5394008"   "5399902"   "5402318"   "5468694").PN.) 5639989.URPN. (("5146047"   "5166772"   "5166864"   "5175613"   "5341274"   "5379185"   "5392197"   "5394304"   "5513078").PN.) 5633785.URPN. (("3566203"   "4744008"   "4945399"   "4949163"   "4984065"   "4994895"   "5049979"   "5055966"   "5119172"   "5148265"   "5148266"   "5281846"   "5311057").PN.) 4982311.URPN. (("4249196"   "4577214"   "4654694"   "4724472"   "4744008"   "4755910").PN.)) not (((("6184567") or ("5633785") or ("5883428") or ("6068782") or ("5639989") or ("4982311")).PN.))	USPAT	2002/02/04 16:24
-	5	5831825.URPN.	USPAT	2002/02/04 14:58

-	11	("4731701"   "4982311"   "5050040"   "5319237"   "5347091"   "5471366"   "5475264"   "5506755"   "5583377"   "5600541"   "5608261").PN.	USPAT	2002/02/04 14:58
-	8	("3880493"   "4249196"   "4654694"   "4739448"   "4982311"   "5095402"   "5212402"   "5272590").PN.	USPAT	2002/02/04 14:58
-	6	5475565.URPN.	USPAT	2002/02/04 14:58
-	14	4949163.URPN.	USPAT	2002/02/04 14:58
-	1	"4751482".PN.	USPAT	2002/02/04 14:58
-	13	4755910.URPN.	USPAT	2002/02/04 14:59
-	15	("4288841"   "4320438"   "4408256"   "4413170"   "4518818"   "4546028"   "4553020"   "4559579"   "4563725"   "4578697"   "4614194"   "4628407"   "4639826"   "4651192"   "4654694").PN.	USPAT	2002/02/04 14:59
-	62	(5831825.URPN. (("4731701"   "4982311"   "5050040"   "5319237"   "5347091"   "5471366"   "5475264"   "5506755"   "5583377"   "5600541"   "5608261").PN.) (("3880493"   "4249196"   "4654694"   "4739448"   "4982311"   "5095402"   "5212402"   "5272590").PN.) 5475565.URPN. 4949163.URPN. "4751482".PN. 4755910.URPN. (("4288841"   "4320438"   "4408256"   "4413170"   "4518818"   "4546028"   "4553020"   "4559579"   "4563725"   "4578697"   "4614194"   "4628407"   "4639826"   "4651192"   "4654694").PN.)) not (6184567.URPN. (("4494169"   "5099388"   "5144526"   "5590017"   "5767564").PN.) 6068782.URPN. (("4065742"   "4409608"   "4437140"   "4460938"   "4490429"   "4650544"   "4878155"   "4908258"   "5010641"   "5027253"   "5065284"   "5079069"   "5155655"   "5161086"   "5162977"   "5261153"   "5347258"   "5656834").PN.) 5883428.URPN. (("4835344"   "5370907"   "5371403"   "5394008"   "5399902"   "5402318"   "5468694").PN.) 5639989.URPN. (("5146047"   "5166772"   "5166864"   "5175613"   "5341274"   "5379185"   "5392197"   "5394304"   "5513078").PN.) 5633785.URPN. (("3566203"   "4744008"   "4945399"   "4949163"   "4984065"   "4994895"   "5049979"   "5055966"   "5119172"   "5148265"   "5148266"   "5281846"   "5311057").PN.) 4982311.URPN. (("4249196"   "4577214"   "4654694"   "4724472"   "4744008"   "4755910").PN.) (((("6184567") or ("5633785") or ("5883428") or ("6068782") or ("5639989") or ("4982311")).PN.)) (("257/532").CCLS.) and decoup\$5 with capacit\$5	USPAT	2002/02/04 15:00
-	84		USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/02/04 16:25
-	15584	"84" and @pd>=20011025	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/02/04 15:16
-	7	((("257/532").CCLS.) and decoup\$5 with capacit\$5) and @pd>=20011025	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/02/04 15:43

-	514	embed\$4 near capacit\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/02/04 15:42
-	27	(embed\$4 near capacit\$5) and @pd>=20011025	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/02/04 15:44
-	1	nanofarrad\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/02/04 16:25
-	682	nanofarad\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/02/04 16:40
-	58	nanofarad\$5 and decoup\$5 with capacit\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/02/04 16:45
-	112	polymer with ceramic with dielectric adj constant	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/02/04 16:40
-	125	polymer with (metal adj oxide\$1 ceramic\$1) with dielectric adj constant	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/02/04 16:45
-	59	"nF/cm.sup.2"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/02/04 16:45
-	8	"nF/cm.sup.2" and decoup\$5 with capacit\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/02/04 16:46
-	0	("substrate with polymer with particle\$1").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/12 17:10
-	3528	substrate with polymer with particle\$1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/12 17:15
-	2	substrate with polymer with high adj dielectric near2 particle\$1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/12 17:20
-	3	substrate with (polyimide polymeric polymer) with high adj dielectric near2 particle\$1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/12 17:23
-	1	(substrate with (polyimide polymeric polymer) with high adj dielectric near2 particle\$1) not (substrate with polymer with high adj dielectric near2 particle\$1)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/12 17:30